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#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2420-i-sp

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



## 3.0 POWER-MANAGED MODES

PIC18F2420/2520/4420/4520 devices offer a total of seven operating modes for more efficient powermanagement. These modes provide a variety of options for selective power conservation in applications where resources may be limited (i.e., battery-powered devices).

There are three categories of power-managed modes:

- Run modes
- Idle modes
- · Sleep mode

These categories define which portions of the device are clocked and sometimes, what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block); the Sleep mode does not use a clock source.

The power-managed modes include several powersaving features offered on previous PIC<sup>®</sup> devices. One is the clock switching feature, offered in other PIC18 devices, allowing the controller to use the Timer1 oscillator in place of the primary oscillator. Also included is the Sleep mode, offered by all PIC devices, where all device clocks are stopped.

#### 3.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions: if the CPU is to be clocked or not and the selection of a clock source. The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 3-1.

## 3.1.1 CLOCK SOURCES

The SCS<1:0> bits allow the selection of one of three clock sources for power-managed modes. They are:

- the primary clock, as defined by the FOSC<3:0> Configuration bits
- the secondary clock (the Timer1 oscillator)
- the internal oscillator block (for RC modes)

#### 3.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source and determine which Run or Idle mode is to be used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These are discussed in **Section 3.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured correctly, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

Mada	OSCCON	OSCCON<7,1:0> Bits		Clocking					
wode	IDLEN <sup>(1)</sup>	SCS<1:0>	CPU	Peripherals	Available Clock and Oscillator Source				
Sleep	0	N/A	Off	Off	None – All clocks are disabled				
PRI_RUN	N/A	00	Clocked	Clocked	Primary – LP, XT, HS, HSPLL, RC, EC and Internal Oscillator Block <sup>(2)</sup> . This is the normal full-power execution mode.				
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – Timer1 Oscillator				
RC_RUN	N/A	1x	Clocked	Clocked	Internal Oscillator Block <sup>(2)</sup>				
PRI_IDLE	1	00	Off	Clocked	Primary – LP, XT, HS, HSPLL, RC, EC				
SEC_IDLE	1	01	Off	Clocked	Secondary – Timer1 Oscillator				
RC_IDLE	1	1x	Off	Clocked	Internal Oscillator Block <sup>(2)</sup>				

TABLE 3-1: POWER-MANAGED MODES

Note 1: IDLEN reflects its value when the **SLEEP** instruction is executed.

2: Includes INTOSC and INTOSC postscaler, as well as the INTRC source.

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets	Wake-up via WDT or Interrupt		
IPR2	2420	2520	4420	4520	11-1 1111	11-1 1111	uu-u uuuu
PIR2	2420	2520	4420	4520	00-0 0000	00-0 0000	uu-u uuuu <b>(1)</b>
PIE2	2420	2520	4420	4520	00-0 0000	00-0 0000	uu-u uuuu
	2420	2520	4420	4520	1111 1111	1111 1111	սսսս սսսս
	2420	2520	4420	4520	-111 1111	-111 1111	-uuu uuuu
	2420	2520	4420	4520	0000 0000	0000 0000	uuuu uuuu <b>(1)</b>
	2420	2520	4420	4520	-000 0000	-000 0000	-uuu uuuu <b>(1)</b>
	2420	2520	4420	4520	0000 0000	0000 0000	uuuu uuuu
PIEI	2420	2520	4420	4520	-000 0000	-000 0000	-uuu uuuu
OSCTUNE	2420	2520	4420	4520	00-0 0000	00-0 0000	uu-u uuuu
TRISE	2420	2520	4420	4520	0000 -111	0000 -111	uuuu -uuu
TRISD	2420	2520	4420	4520	1111 1111	1111 1111	uuuu uuuu
TRISC	2420	2520	4420	4520	1111 1111	1111 1111	uuuu uuuu
TRISB	2420	2520	4420	4520	1111 1111	1111 1111	uuuu uuuu
TRISA <sup>(5)</sup>	2420	2520	4420	4520	1111 1111 <b>(5)</b>	1111 1111(5)	uuuu uuuu <b>(5)</b>
LATE	2420	2520	4420	4520	xxx	uuu	uuu
LATD	2420	2520	4420	4520	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	2420	2520	4420	4520	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	2420	2520	4420	4520	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA <sup>(5)</sup>	2420	2520	4420	4520	xxxx xxxx(5)	uuuu uuuu <b>(5)</b>	uuuu uuuu <b>(5)</b>
PORTE	2420	2520	4420	4520	xxxx	uuuu	uuuu
PORTD	2420	2520	4420	4520	XXXX XXXX	uuuu uuuu	uuuu uuuu
PORTC	2420	2520	4420	4520	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	2420	2520	4420	4520	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA <sup>(5)</sup>	2420	2520	4420	4520	xx0x 0000 <b>(5)</b>	uu0u 0000 <b>(5)</b>	uuuu uuuu <sup>(5)</sup>

#### TABLE 4-4: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition.

Shaded cells indicate conditions do not apply for the designated device.

Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

**3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

4: See Table 4-3 for Reset value for specific condition.

5: Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read '0'.

**6:** The Reset value of the PCFG bits depends on the value of the PBADEN Configuration bit (CONFIG3H<1>). When PBADEN = 1, PCFG<2:0> = 000; when PBADEN = 0, PCFG<2:0> = 111.

#### 5.3 Data Memory Organization

Note: The operation of some aspects of data memory are changed when the PIC18 extended instruction set is enabled. See Section 5.5 "Data Memory and the Extended Instruction Set" for more information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each; PIC18F2420/2520/4420/4520 devices implement all 16 banks. Figure 5-5 shows the data memory organization for the PIC18F2420/2520/4420/4520 devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this subsection.

To ensure that commonly used registers (SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to SFRs and the lower portion of GPR Bank 0 without using the BSR. **Section 5.3.2** "Access Bank" provides a detailed description of the Access RAM.

#### 5.3.1 BANK SELECT REGISTER (BSR)

Large areas of data memory require an efficient addressing scheme to make rapid access to any address possible. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit low-order address and a 4-bit Bank Pointer.

Most instructions in the PIC18 instruction set make use of the Bank Pointer, known as the Bank Select Register (BSR). This SFR holds the 4 Most Significant bits of a location's address; the instruction itself includes the 8 Least Significant bits. Only the four lower bits of the BSR are implemented (BSR<3:0>). The upper four bits are unused; they will always read '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

The value of the BSR indicates the bank in data memory; the 8 bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 5-7.

Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h while the BSR is 0Fh will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 5-5 indicates which banks are implemented.

In the core PIC18 instruction set, only the MOVFF instruction fully specifies the 12-bit address of the source and target registers. This instruction ignores the BSR completely when it executes. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.

### 6.4 Erasing Flash Program Memory

The minimum erase block is 32 words or 64 bytes. Only through the use of an external programmer, or through ICSP control, can larger blocks of program memory be bulk erased. Word erase in the Flash array is not supported.

When initiating an erase sequence from the microcontroller itself, a block of 64 bytes of program memory is erased. The Most Significant 16 bits of the TBLPTR<21:6> point to the block being erased. TBLPTR<5:0> are ignored.

The EECON1 register commands the erase operation. The EEPGD bit must be set to point to the Flash program memory. The WREN bit must be set to enable write operations. The FREE bit is set to select an erase operation.

For protection, the write initiate sequence for EECON2 must be used.

A long write is necessary for erasing the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

#### 6.4.1 FLASH PROGRAM MEMORY ERASE SEQUENCE

The sequence of events for erasing a block of internal program memory location is:

- 1. Load Table Pointer register with address of row being erased.
- 2. Set the EECON1 register for the erase operation:
  - set EEPGD bit to point to program memory;
  - · clear the CFGS bit to access program memory;
  - set WREN bit to enable writes;
  - set FREE bit to enable the erase.
- 3. Disable interrupts.
- 4. Write 55h to EECON2.
- 5. Write 0AAh to EECON2.
- 6. Set the WR bit. This will begin the row erase cycle.
- 7. The CPU will stall for duration of the erase (about 2 ms using internal timer).
- 8. Re-enable interrupts.

	MOVLW MOVWF MOVLW MOVWF MOVLW MOVWF	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH TBLPTRH CODE_ADDR_LOW TBLPTRL	; load TBLPTR with the base ; address of the memory block
ERASE_ROW			
	BSF	EECON1, EEPGD	; point to Flash program memory
	BCF	EECON1, CFGS	; access Flash program memory
	BSF	EECON1, WREN	; enable write to memory
	BSF	EECON1, FREE	; enable Row Erase operation
	BCF	INTCON, GIE	; disable interrupts
Required	MOVLW	55h	
Sequence	MOVWF	EECON2	; write 55h
	MOVLW	0AAh	
	MOVWF	EECON2	; write OAAh
	BSF	EECON1, WR	; start erase (CPU stall)
	BSF	INTCON, GIE	; re-enable interrupts

#### EXAMPLE 6-2: ERASING A FLASH PROGRAM MEMORY ROW

#### 9.1 INTCON Registers

The INTCON registers are readable and writable registers, which contain various enable, priority and flag bits.

**Note:** Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

#### REGISTER 9-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INTOIE	RBIE	TMR0IF	INT0IF	RBIF <sup>(1)</sup>
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	GIE/GIEH: Global Interrupt Enable bit When IPEN = 0: 1 = Enables all unmasked interrupts 0 = Disables all interrupts When IPEN = 1: 1 = Enables all high-priority interrupts 0 = Disables all interrupts
bit 6	PEIE/GIEL: Peripheral Interrupt Enable bit <u>When IPEN = 0:</u> 1 = Enables all unmasked peripheral interrupts 0 = Disables all peripheral interrupts <u>When IPEN = 1:</u> 1 = Enables all low-priority peripheral interrupts 0 = Disables all low-priority peripheral interrupts
bit 5	<b>TMR0IE:</b> TMR0 Overflow Interrupt Enable bit 1 = Enables the TMR0 overflow interrupt 0 = Disables the TMR0 overflow interrupt
bit 4	INTOIE: INTO External Interrupt Enable bit 1 = Enables the INTO external interrupt 0 = Disables the INTO external interrupt
bit 3	<b>RBIE:</b> RB Port Change Interrupt Enable bit 1 = Enables the RB port change interrupt 0 = Disables the RB port change interrupt
bit 2	<b>TMR0IF:</b> TMR0 Overflow Interrupt Flag bit 1 = TMR0 register has overflowed (must be cleared in software) 0 = TMR0 register did not overflow
bit 1	INTOIF: INTO External Interrupt Flag bit 1 = The INTO external interrupt occurred (must be cleared in software) 0 = The INTO external interrupt did not occur
bit 0	<b>RBIF:</b> RB Port Change Interrupt Flag bit <sup>(1)</sup> 1 = At least one of the RB<7:4> pins changed state (must be cleared in software) 0 = None of the RB<7:4> pins have changed state

**Note 1:** A mismatch condition will continue to set this bit. Reading PORTB will end the mismatch condition and allow the bit to be cleared.

### 9.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are two Peripheral Interrupt Request Flag registers (PIR1 and PIR2).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
  - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

#### REGISTER 9-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

. .. (1)

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bit /	PSPIF: Parallel Slave Port Read/Write Interrupt Flag bit'
	<ul> <li>1 = A read or a write operation has taken place (must be cleared in software)</li> <li>0 = No read or write has occurred</li> </ul>
bit 6	ADIF: A/D Converter Interrupt Flag bit
	<ul><li>1 = An A/D conversion completed (must be cleared in software)</li><li>0 = The A/D conversion is not complete</li></ul>
bit 5	RCIF: EUSART Receive Interrupt Flag bit
	<ul> <li>1 = The EUSART receive buffer, RCREG, is full (cleared when RCREG is read)</li> <li>0 = The EUSART receive buffer is empty</li> </ul>
bit 4	TXIF: EUSART Transmit Interrupt Flag bit
	<ul> <li>1 = The EUSART transmit buffer, TXREG, is empty (cleared when TXREG is written)</li> <li>0 = The EUSART transmit buffer is full</li> </ul>
bit 3	SSPIF: Master Synchronous Serial Port Interrupt Flag bit
	<ul><li>1 = The transmission/reception is complete (must be cleared in software)</li><li>0 = Waiting to transmit/receive</li></ul>
bit 2	CCP1IF: CCP1 Interrupt Flag bit
	<u>Capture mode:</u> 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred
	<u>Compare mode:</u> 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred <u>PWM mode:</u> Unused in this mode.
bit 1	TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
	<ul><li>1 = TMR2 to PR2 match occurred (must be cleared in software)</li><li>0 = No TMR2 to PR2 match occurred</li></ul>
bit 0	<pre>TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflowed (must be cleared in software) 0 = TMR1 register did not overflow</pre>

Note 1: This bit is unimplemented on 28-pin devices and will read as '0'.

### 9.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are two Peripheral Interrupt Priority registers (IPR1 and IPR2). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit be set.

#### REGISTER 9-8: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

PSPIP <sup>(1)</sup> ADIP RCIP TXIP SSPIP CCP1IP TMR2IP TMR2	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
bit 7	PSPIP <sup>(1)</sup>	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP
	bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	<pre>PSPIP: Parallel Slave Port Read/Write Interrupt Priority bit<sup>(1)</sup> 1 = High priority 0 = Low priority</pre>
bit 6	ADIP: A/D Converter Interrupt Priority bit 1 = High priority 0 = Low priority
bit 5	<b>RCIP:</b> EUSART Receive Interrupt Priority bit 1 = High priority 0 = Low priority
bit 4	<ul><li><b>TXIP:</b> EUSART Transmit Interrupt Priority bit</li><li>1 = High priority</li><li>0 = Low priority</li></ul>
bit 3	<b>SSPIP:</b> Master Synchronous Serial Port Interrupt Priority bit 1 = High priority 0 = Low priority
bit 2	<b>CCP1IP:</b> CCP1 Interrupt Priority bit 1 = High priority 0 = Low priority
bit 1	<b>TMR2IP:</b> TMR2 to PR2 Match Interrupt Priority bit 1 = High priority 0 = Low priority
bit 0	<b>TMR1IP:</b> TMR1 Overflow Interrupt Priority bit 1 = High priority 0 = Low priority



## 17.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

#### 17.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I<sup>2</sup>C)
  - Full Master mode
  - Slave mode (with general address call)

The  $I^2C$  interface supports the following modes in hardware:

- Master mode
- · Multi-Master mode
- Slave mode

## 17.2 Control Registers

The MSSP module has three associated registers. These include a status register (SSPSTAT) and two control registers (SSPCON1 and SSPCON2). The use of these registers and their individual configuration bits differ significantly depending on whether the MSSP module is operated in SPI or  $I^2C$  mode.

Additional details are provided under the individual sections.

#### 17.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO) RC5/SDO
- Serial Data In (SDI) RC4/SDI/SDA
- Serial Clock (SCK) RC3/SCK/SCL

Additionally, a fourth pin may be used when in a Slave mode of operation:

Slave Select (SS) – RA5/SS

Figure 17-1 shows the block diagram of the MSSP module when operating in SPI mode.





#### 17.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the  $I^2C$  bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I<sup>2</sup>C protocol. It consists of all '0's with R/W = 0.

The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPCON2<7> is set). Following a Start bit detect, 8 bits are shifted into the SSPSR and the address is compared against the SSPADD. It is also compared to the general call address and fixed in hardware. If the general call address matches, the SSPSR is transferred to the SSPBUF, the BF flag bit is set (eighth bit) and on the falling edge of the ninth bit (ACK bit), the SSPIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPBUF. The value can be used to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPADD is required to be updated for the second half of the address to match and the UA bit is set (SSPSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-Bit Addressing mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 17-15).





		SYNC = 0, BRGH = 0, BRG16 = 1											
BAUD	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665	
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415	
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207	
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51	
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25	
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8	
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	_	_	

## TABLE 18-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

	SYNC = 0, BRGH = 0, BRG16 = 1										
BAUD	Foso	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz				
(K)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)		
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207		
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51		
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25		
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_		
19.2	19.231	0.16	12	_	_	_	_	_	_		
57.6	62.500	8.51	3	_	_	_	_	_	_		
115.2	125.000	8.51	1	_		—	_	_	_		

				SYNC = 0	, BRGH =	= 1, BRG16	5 = 1 or SY	'NC = 1,	BRG16 = 1			
BAUD	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG Value (decimal)									
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16

		SYN	IC = 0, BR	GH = 1, BI	<b>RG16 =</b> 1	or SYNC =	= 1, BRG1	6 = 1	
BAUD	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12
57.6	58.824	2.12	16	55.555	3.55	8	—	_	_
115.2	111.111	-3.55	8	_	_		—	_	_

NOTES:

MOVSS	Move Indexed to Indexed								
Syntax:	MOVSS	[z <sub>s</sub> ], [z <sub>d</sub> ]							
Operands:	$0 \le z_s \le 12$ $0 \le z_d \le 12$	27 27							
Operation:	((FSR2) +	$z_s) \rightarrow ((F$	SR2) + z <sub>d</sub>	)					
Status Affected:	None								
Encoding: 1st word (source) 2nd word (dest.)	1110 1111	1110 1011 1zzz zzzzg							
Description	The conter moved to t addresses registers a 7-bit literal respective registers c the 4096-b (000h to F The MOVS PCL, TOS destination If the resul an indirect value retur resultant d an indirect	nts of the the destin of the source of the source offsets 'z ly, to the v an be loc oyte data FFh). s instructi U, TOSH register. tant source addressi rened will b lestination addressi will exect	source reg ation regis urce and de inned by ac s' or 'zd', value of FS ated anyw memory sp on cannot or TOSL a ce address ng register the 00h. If the address p ng register ute as a No	gister are ter. The estination dding the SR2. Both here in bace use the as the points to c, the points to c, the OP.					
Words:	2								
Cycles:	2								
Q Cycle Activity:									
Q1	Q2	Q3	5	Q4					

QI	QZ	QS	Q4	
Decode	Determine	Determine	Read	
	source addr	source addr	source reg	
Decode	Determine dest addr	Determine dest addr	Write to dest reg	

Example:	MOVSS	[05h],	[06h]
Before Instruction	on		
FSR2	=	80h	
Contents of 85h Contents	=	33h	
of 86h	=	11h	
After Instruction			
FSR2	=	80h	
Contents of 85h Contents	=	33h	
of 86h	=	33h	

PUSHL	Store Liter	al at FSI	R2, Decr	ement FSR2		
Syntax:	PUSHL k					
Operands:	$0 \le k \le 255$					
Operation:	$k \rightarrow (FSR2)$ FSR2 – 1 –	), → FSR2				
Status Affected:	None					
Encoding:	1111	1010	kkkk	kkkk		
Description.	memory address specified by FSR2. FSF is decremented by 1 after the operation. This instruction allows users to push valu onto a software stack.					
Words:	1					
Cycles:	1					
Q Cycle Activity	/:					
Q1	Q2		Q3	Q4		
Decode	Read '	k' Pr	ocess data	Write to destination		
<u>Example</u> : Before Inst FSR2 Memo	PUSHL ruction H:FSR2L ory (01ECh)	08h = =	01ECh 00h	L		
After Instru	ction					

FSR2H:FSR2L	=	01EBh
Memory (01ECh)	=	08h

## 25.2 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for all PIC MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel<sup>®</sup> standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

### 25.3 MPLAB C18 and MPLAB C30 C Compilers

The MPLAB C18 and MPLAB C30 Code Development Systems are complete ANSI C compilers for Microchip's PIC18 and PIC24 families of microcontrollers and the dsPIC30 and dsPIC33 family of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use not found with other compilers.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

### 25.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

## 25.5 MPLAB ASM30 Assembler, Linker and Librarian

MPLAB ASM30 Assembler produces relocatable machine code from symbolic assembly language for dsPIC30F devices. MPLAB C30 C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire dsPIC30F instruction set
- · Support for fixed-point and floating-point data
- · Command line interface
- Rich directive set
- Flexible macro language
- · MPLAB IDE compatibility

## 25.6 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC<sup>®</sup> DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C18 and MPLAB C30 C Compilers, and the MPASM and MPLAB ASM30 Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

### 25.7 MPLAB ICE 2000 High-Performance In-Circuit Emulator

The MPLAB ICE 2000 In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers. Software control of the MPLAB ICE 2000 In-Circuit Emulator is advanced by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The architecture of the MPLAB ICE 2000 In-Circuit Emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE 2000 In-Circuit Emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft<sup>®</sup> Windows<sup>®</sup> 32-bit operating system were chosen to best make these features available in a simple, unified application.

## 25.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC<sup>®</sup> Flash MCUs and dsPIC<sup>®</sup> Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The MPLAB REAL ICE probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with the popular MPLAB ICD 2 system (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

MPLAB REAL ICE is field upgradeable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added, such as software breakpoints and assembly code trace. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, real-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

## 25.9 MPLAB ICD 2 In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD 2, is a powerful, low-cost, run-time development tool, connecting to the host PC via an RS-232 or high-speed USB interface. This tool is based on the Flash PIC MCUs and can be used to develop for these and other PIC MCUs and dsPIC DSCs. The MPLAB ICD 2 utilizes the in-circuit debugging capability built into the Flash devices. This feature, along with Microchip's In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) protocol, offers costeffective, in-circuit Flash debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by setting breakpoints, single stepping and watching variables, and CPU status and peripheral registers. Running at full speed enables testing hardware and applications in real time. MPLAB ICD 2 also serves as a development programmer for selected PIC devices.

## 25.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an SD/MMC card for file storage and secure data applications.

## 26.2 DC Characteristics: Power-Down and Supply Current PIC18F2420/2520/4420/4520 (Industrial) PIC18LF2420/2520/4420/4520 (Industrial)

PIC18LF24 (Indust	<b>420/2520/4420/4520</b> :rial)	<b>Standa</b> Operati	ird Ope	rating C	Conditions (unless otherwise s $-40^{\circ}C \le TA \le +85^{\circ}C$ for inc	tated) Iustrial		
PIC18F242 (Indust	<b>Standa</b> Operati	andard Operating Conditions (unless otherwise stated)perating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended						
Param No.	Device	Тур	Max	Units	Condit	ions		
	Power-Down Current (IPD)	(1)						
	PIC18LF2X2X/4X20	0.1	0.5	μΑ	-40°C	N/== 0.0N/		
		0.1	0.5	μΑ	+25°C	VDD = 2.0V ( <b>Sleen</b> mode)		
		0.2	2.5	μΑ	+85°C	( <b>Dieep</b> mode)		
	PIC18LF2X2X/4X20	0.1	0.7	μΑ	-40°C			
		0.1	0.7	μA	+25°C	VDD = 3.0V (Sleep mode)		
		0.3	3.5	μΑ	+85°C	( <b>Dieep</b> mode)		
	All devices	0.1	1.0	μA	-40°C			
		0.2	1.0	μA	+25°C	VDD = 5.0V		
		0.7	10	μA	+85°C	( <b>Sleep</b> mode)		
	Extended devices only	10	100	μA	+125°C			

Legend: Shading of rows is to assist in readability of the table.

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, etc.).

- 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
  - The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD or VSS;

- $\overline{MCLR}$  = VDD; WDT enabled/disabled as specified.
- **3:** When operation below -10°C is expected, use T1OSC High-Power mode, where LPT1OSC (CONFIG3H<2>) = 0. When operation will always be above -10°C, then the low-power Timer1 oscillator may be selected.
- 4: BOR and HLVD enable internal band gap reference. With both modules enabled, current consumption will be less than the sum of both specifications.

#### FIGURE 26-10: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS



Param No.	Symbol		Characterist	ic	Min	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width		No prescaler	0.5 Tcy + 20	—	ns	
				With prescaler	10		ns	
41	TtOL	T0CKI Low Pulse Width		No prescaler	0.5 Tcy + 20	_	ns	
				With prescaler	10	_	ns	
42	Tt0P	T0CKI Period		No prescaler	Tcy + 10	_	ns	
				With prescaler	Greater of: 20 ns or (Tcy + 40)/N	_	ns	N = prescale value (1, 2, 4,, 256)
45	Tt1H	T13CKI High Time	Synchronous, no	prescaler	0.5 Tcy + 20	—	ns	
			Synchronous, with prescaler	PIC18FXXXX	10	—	ns	
				PIC18LFXXXX	25	—	ns	VDD = 2.0V
			Asynchronous	PIC18FXXXX	30	—	ns	
				PIC18LFXXXX	50	—	ns	VDD = 2.0V
46	Tt1L	T13CKI Low Time	Synchronous, no	o prescaler	0.5 Tcy + 5	—	ns	
			Synchronous, with prescaler	PIC18FXXXX	10	—	ns	
				PIC18LFXXXX	25	—	ns	VDD = 2.0V
			Asynchronous	PIC18FXXXX	30	_	ns	
				PIC18LFXXXX	50	—	ns	VDD = 2.0V
47	Tt1P	T13CKI Input Period	Synchronous		Greater of: 20 ns or (Tcy + 40)/N	_	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous		60	_	ns	
	Ft1	T13CKI Oscillator Input Frequency Range			DC	50	kHz	
48	Tcke2tmrl	Delay from External T13CKI Clock Edge to Timer Increment			2 Tosc	7 Tosc		



TABLE 26-25:	<b>A/D CONVERSION REQUIREMENTS</b>

Param No.	Symbol	Characte	Min	Мах	Units	Conditions	
130	Tad	A/D Clock Period	PIC18FXXXX	0.7	25.0 <sup>(1)</sup>	μs	Tosc based, VREF $\geq$ 3.0V
			PIC18LFXXXX	1.4	25.0 <sup>(1)</sup>	μs	VDD = 2.0V; Tosc based, VREF full range
			PIC18 <b>F</b> XXXX		1	μs	A/D RC mode
			PIC18 <b>LF</b> XXXX		3	μs	VDD = 2.0V; A/D RC mode
131	TCNV	Conversion Time (not including acquisition)	11	12	Tad		
132	TACQ	Acquisition Time (Note	1.4	_	μs	-40°C to +85°C	
135	Tswc	Switching Time from C	_	(Note 4)			
TBD	TDIS	Discharge Time	0.2	—	μs		

Note 1: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES register may be read on the following TCY cycle.

3: The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD). The source impedance (Rs) on the input channels is 50 $\Omega$ .

4: On the following cycle of the device clock.

#### W

Watchdog Timer (WDT)	249 258
Associated Registers	
Control Register	
During Oscillator Failure	
Programming Considerations	
WCOL	189, 190, 191, 194
WCOL Status Flag	189, 190, 191, 194
WWW Address	
WWW, On-Line Support	6

## Х

XORLW	. 307
XORWF	. 308

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